

**Product Summary**

<b>BV<sub>SSS</sub></b>	<b>R<sub>SS(ON)</sub> MAX</b>	<b>I<sub>S</sub> T<sub>A</sub> = +25°C</b>
30V	7.8mΩ @ V <sub>GS</sub> = 10V	14.6A

**Description**

This new generation MOSFET has been designed to minimize the on-state resistance (R<sub>SS(ON)</sub>) with a 3.37mm x 1.47mm x 0.2mm size and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

**Applications**

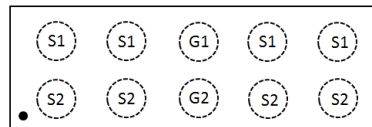
- Battery Management
- Load Switch
- Battery Protection

**Features**

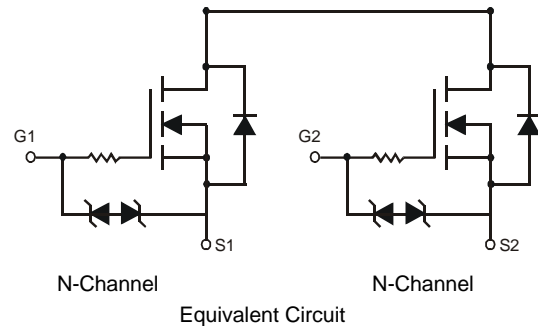
- Built-in G-S Protection Diode Against ESD 2kV HBM.
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

**Mechanical Data**

- Case: X4-DSN3415-10
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram



Top View

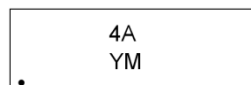


**Ordering Information (Note 4)**

Part Number	Case	Packaging
DMN3008SCP10-7	X4-DSN3415-10	3000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  3. For packaging details, go to our website at

**Marking Information**



4A = Product Type Marking Code  
 YM = Date Code Marking  
 Y or  $\bar{Y}$  = Year (ex: E = 2017)  
 M or  $\bar{M}$  = Month (ex: 9 = September)

Date Code Key

Year	2015	2016	2017	2018	2019	2020	2021					
Code	C	D	E	F	G	H	I					
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Source -Source Voltage			V <sub>SSS</sub>	30	V
Gate-Source Voltage (Note 5)			V <sub>GSS</sub>	±20	V
Continuous Source Current @ T <sub>A</sub> = +25°C (Note 6)	Steady State	T <sub>A</sub> = +25°C	I <sub>S</sub>	14.6	A
		T <sub>A</sub> = +70°C		11.6	
Pulsed Source Current @ T <sub>A</sub> = +25°C (Notes 6 & 7)			I <sub>SM</sub>	80	A

**Thermal Characteristics**

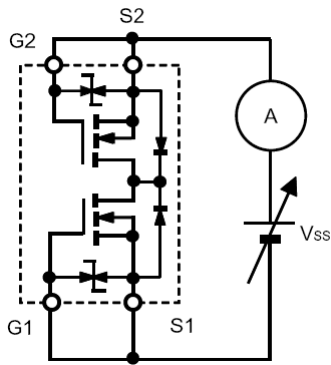
Characteristic	Symbol	Value	Unit
Power Dissipation, @ T <sub>A</sub> = +25°C (Note 6)	P <sub>D</sub>	2.7	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 6)	R <sub>θJA</sub>	46.9	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

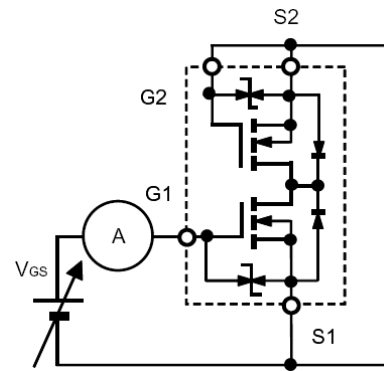
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS (Note 8)</b>						
Source to Source Breakdown Voltage T <sub>J</sub> = +25°C	BV <sub>SSS</sub>	30	—	—	V	I <sub>S</sub> = 250µA, V <sub>GS</sub> = 0V TEST CIRCUIT 1
Zero Gate Voltage Source Current T <sub>J</sub> = +25°C	I <sub>SSS</sub>	—	—	1.0	µA	V <sub>SS</sub> = 24V, V <sub>GS</sub> = 0V TEST CIRCUIT 1
Gate-Body Leakage	I <sub>GSS</sub>	—	—	10	µA	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V TEST CIRCUIT 2
<b>ON CHARACTERISTICS (Note 8)</b>						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.3	1.6	2.3	V	V <sub>SS</sub> = 10V, I <sub>S</sub> = 250µA TEST CIRCUIT 3
Static Source -Source On-Resistance	R <sub>SS(ON)</sub>	—	6.1	7.8	mΩ	V <sub>GS</sub> = 10 V, I <sub>S</sub> = 7.0A TEST CIRCUIT 5
			8.1	11		
Body Diode Forward Voltage	V <sub>F(S-S)</sub>	—	0.8	—	V	I <sub>F</sub> = 7.0A, V <sub>GS</sub> = 0V, TEST CIRCUIT 6
<b>DYNAMIC CHARACTERISTICS (Note 9)</b>						
Input Capacitance	C <sub>iSS</sub>	—	1476	—	pF	V <sub>SS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1.0MHz TEST CIRCUIT 7
Output Capacitance	C <sub>oSS</sub>	—	204	—		
Reverse Transfer Capacitance	C <sub>rSS</sub>	—	97	—		
Gate Resistance	R <sub>g</sub>	—	436.8	—	Ω	V <sub>SS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1MHz
Total Gate Charge (10V)	Q <sub>g</sub>	—	31.3	—	nC	V <sub>SS</sub> = 15V, I <sub>S</sub> = 7A TEST CIRCUIT 9
Total Gate Charge (4.5V)	Q <sub>g</sub>	—	15.8	—	nC	
Gate-Source Charge	Q <sub>gs</sub>	—	4.7	—	nC	
Gate-Drain Charge	Q <sub>gd</sub>	—	6.3	—	nC	
Gate Charge at V <sub>TH</sub>	Q <sub>g(TH)</sub>	—	3.1	—	nC	
Turn-On Delay Time	t <sub>D(ON)</sub>	—	186	—	ns	V <sub>SS</sub> = 15V, R <sub>L</sub> = 2.1Ω, I <sub>S</sub> = 7A TEST CIRCUIT 8
Turn-On Rise Time	t <sub>R</sub>	—	314	—	ns	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	—	928	—	ns	
Turn-Off Fall Time	t <sub>F</sub>	—	858	—	ns	

- Notes:
- AEC-Q101 V<sub>GS</sub> maximum is 16V.
  - Device mounted on FR-4 material with 1inch<sup>2</sup> (6.45cm<sup>2</sup>), 2oz (0.071mm thick) Cu.
  - Repetitive rating, pulse width limited by junction temperature.
  - Short duration pulse test used to minimize self-heating effect.
  - Guaranteed by design. Not subject to production testing.

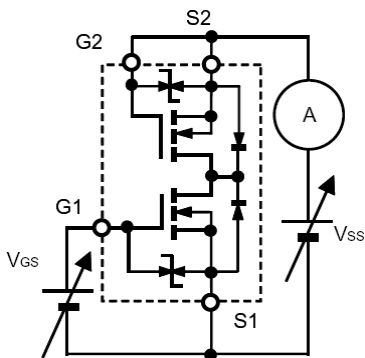
Test Circuits



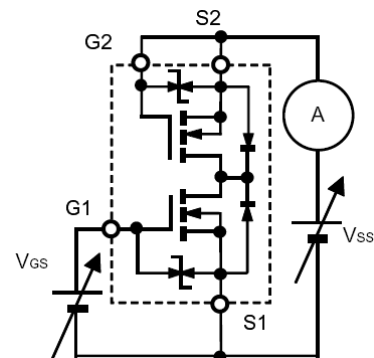
TEST CIRCUIT 1  $I_{SS}$



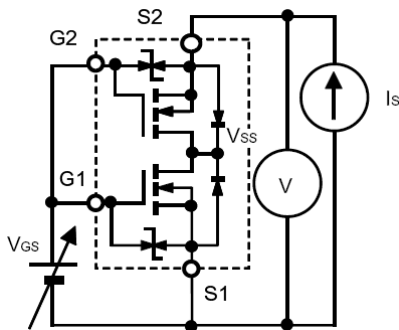
TEST CIRCUIT 2  $I_{GSS}$   
When FET1 is measured, between GATE and SOURCE of FET2 are shorted.



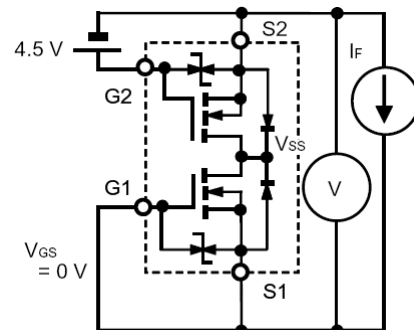
TEST CIRCUIT 3  $V_{GS(OFF)}$   
When FET1 is measured, between GATE and SOURCE of FET2 are shorted.



TEST CIRCUIT 4  $|y_{fs}|$   
 $\Delta I_S / \Delta V_{GS}$

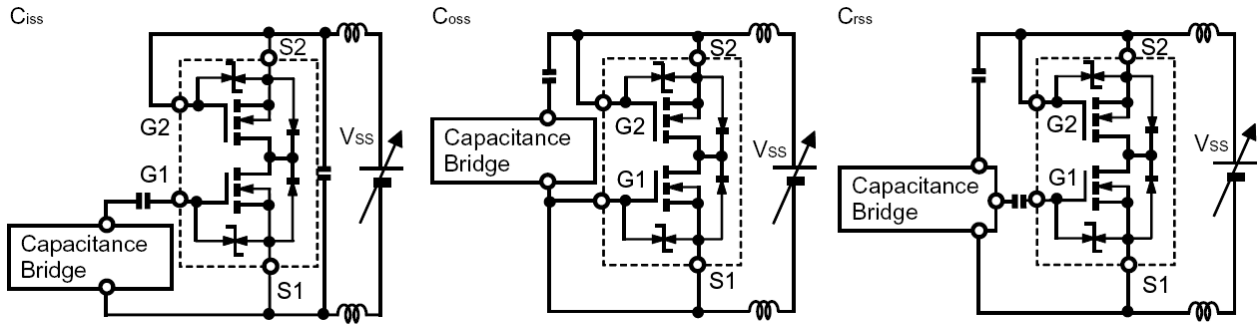


TEST CIRCUIT 5  $R_{SS(ON)}$   
 $V_{SS} / I_S$

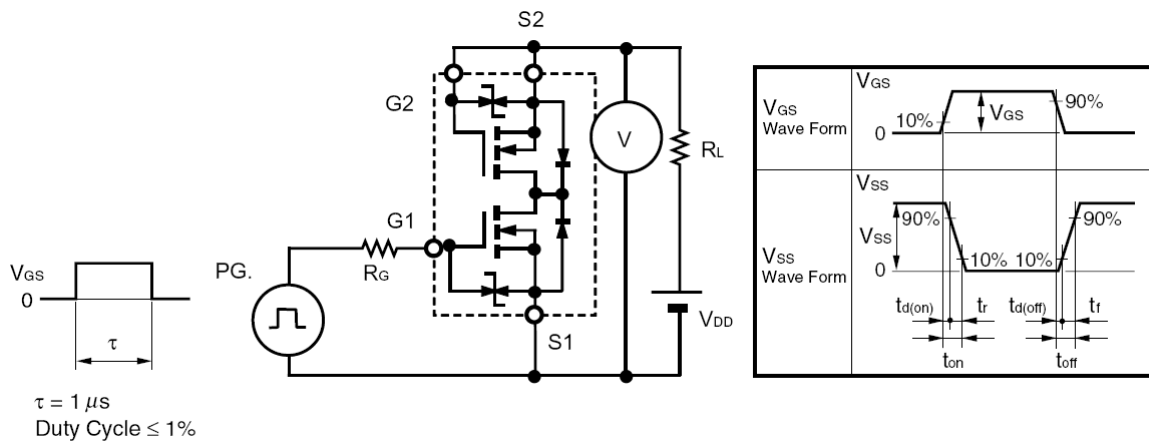


TEST CIRCUIT 6  $V_{F(S-S)}$   
When FET1 is measured, FET2 is added  $V_{GS} + 4.5V$ .

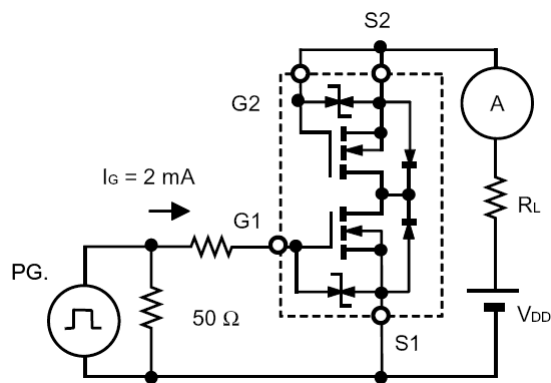
Test Circuits (Cont.)



TEST CIRCUIT 7



TEST CIRCUIT 8  $t_{d(on)}$ ,  $t_r$ ,  $t_{d(off)}$ ,  $t_f$



TEST CIRCUIT 9  $Q_G$

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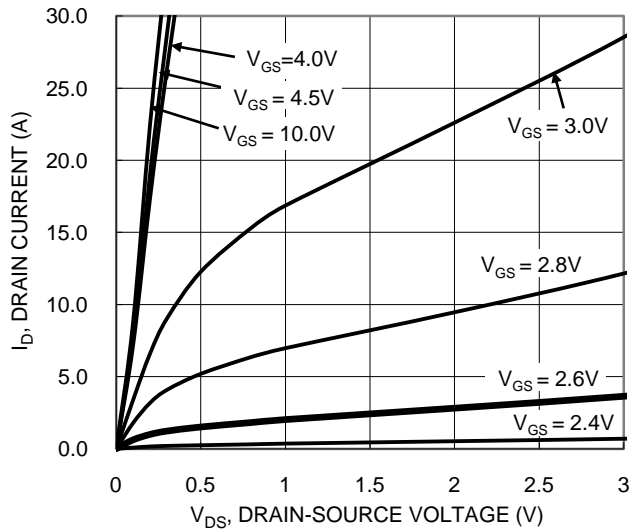


Figure 1. Typical Output Characteristic

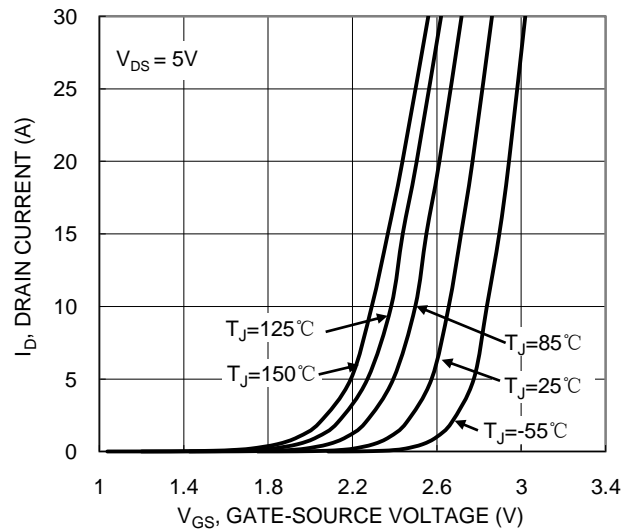


Figure 2. Typical Transfer Characteristic

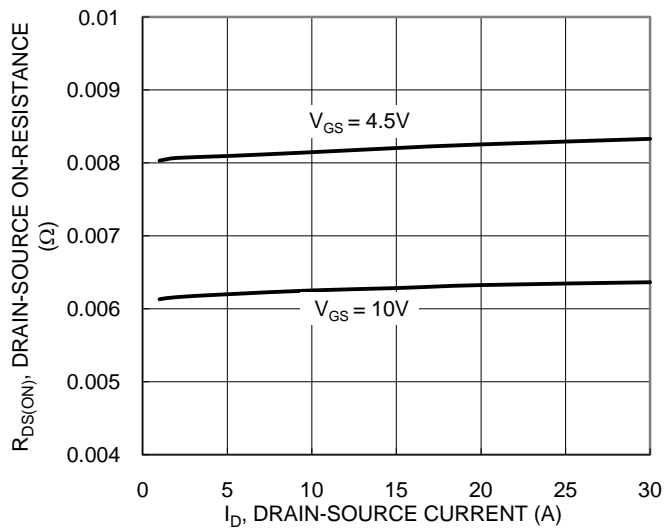


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

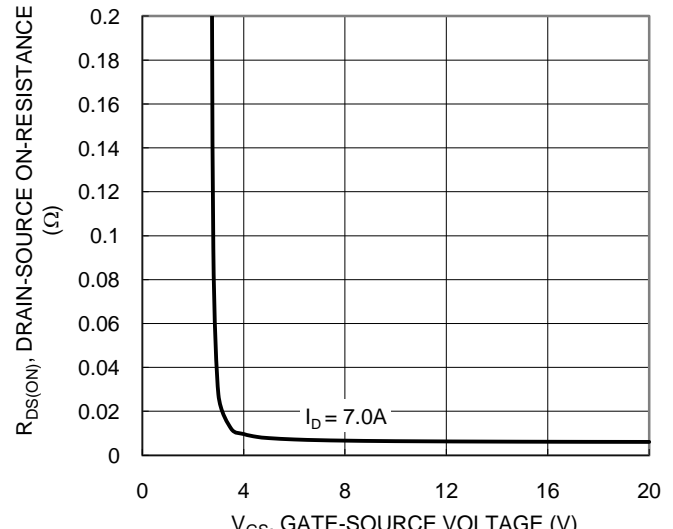


Figure 4. Typical Transfer Characteristic

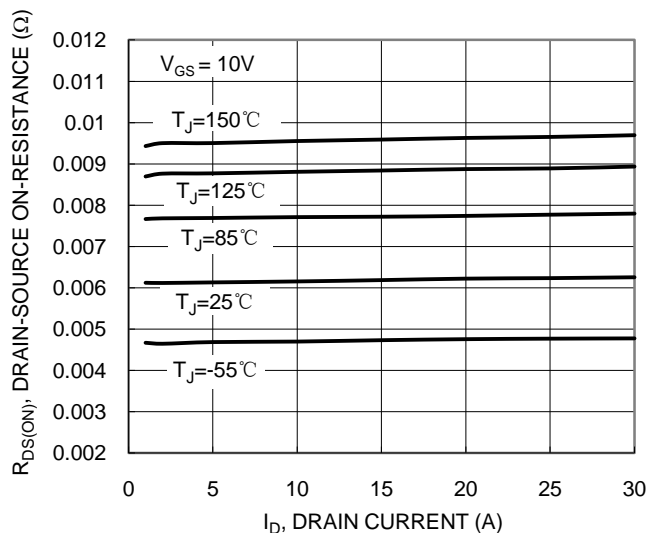


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

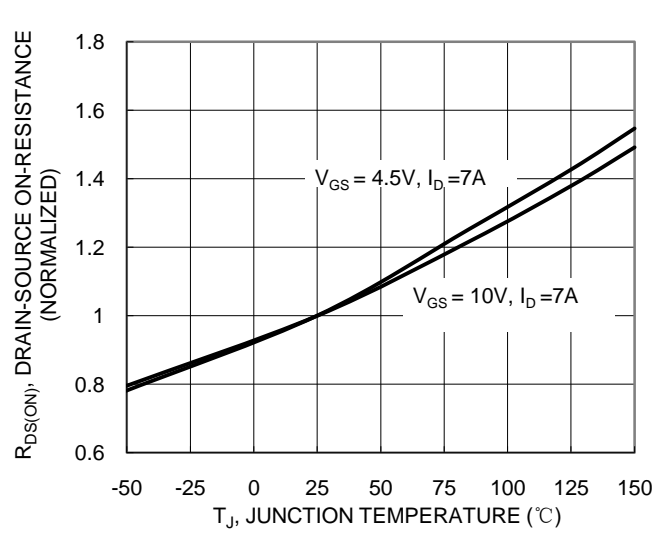
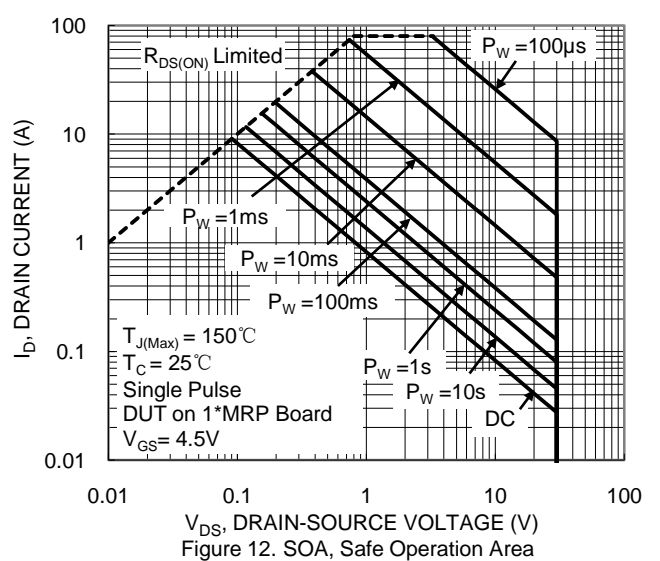
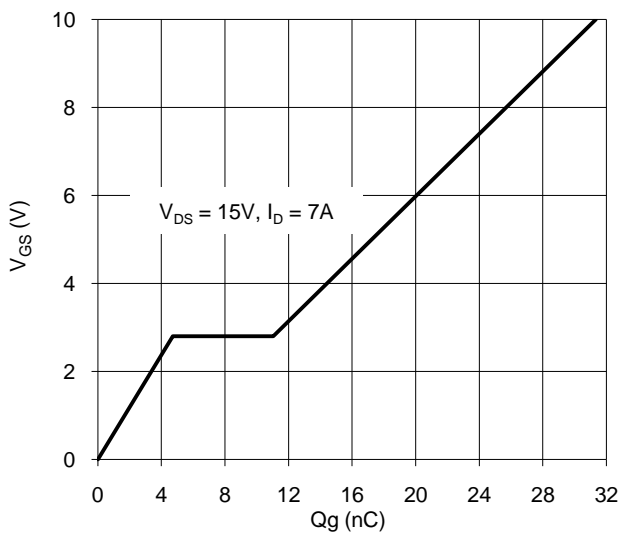
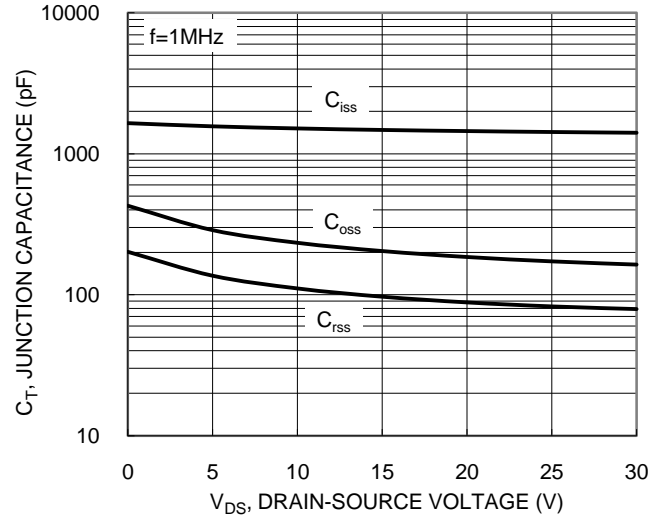
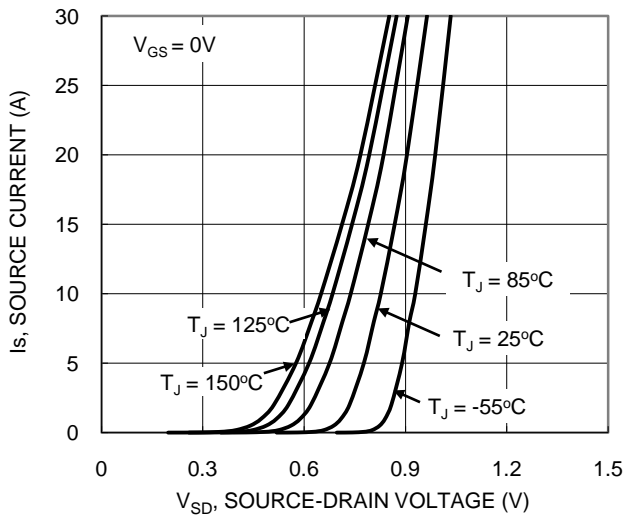
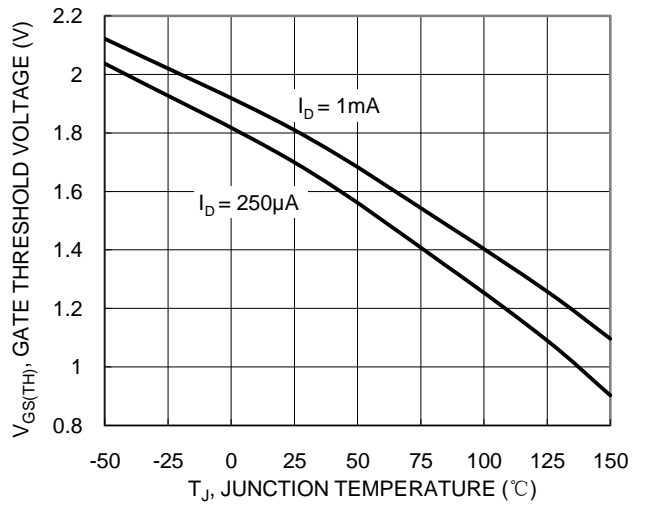
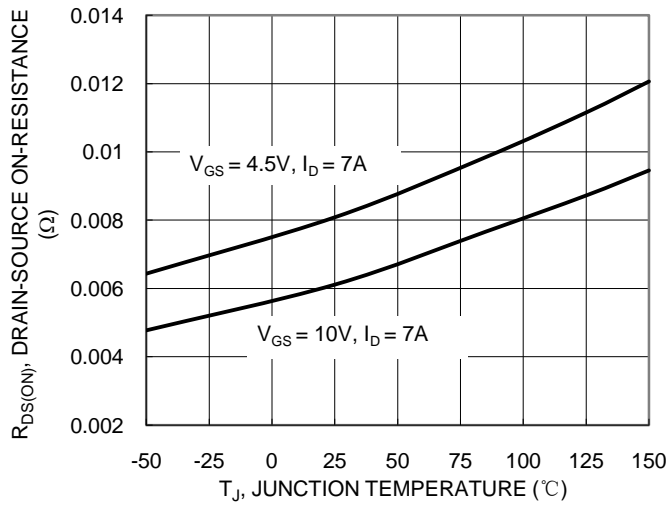


Figure 6. On-Resistance Variation with Junction Temperature

**DMN3008SCP10**



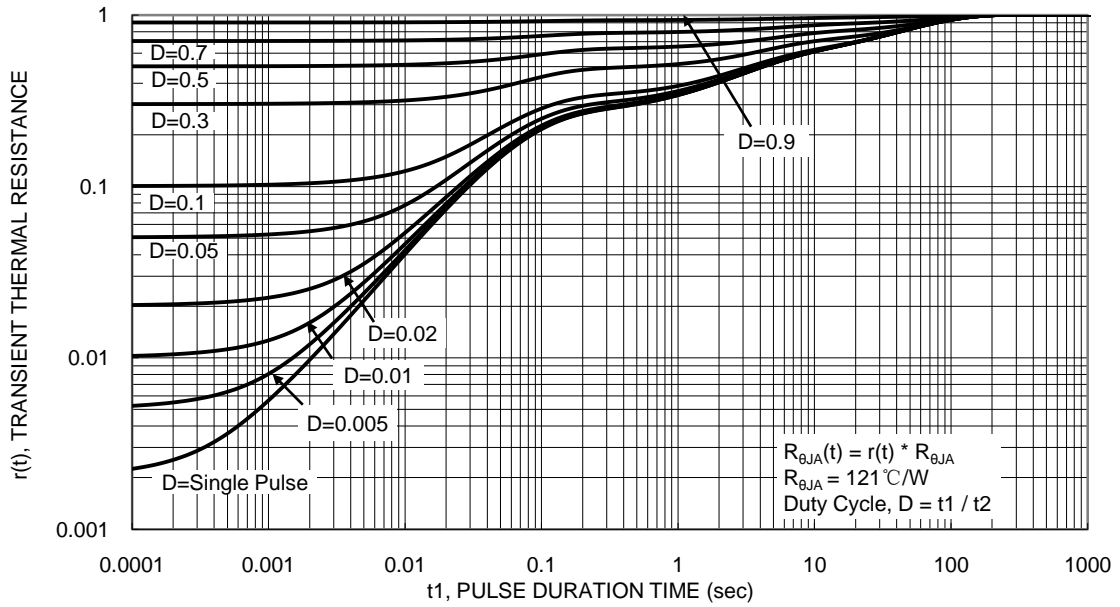
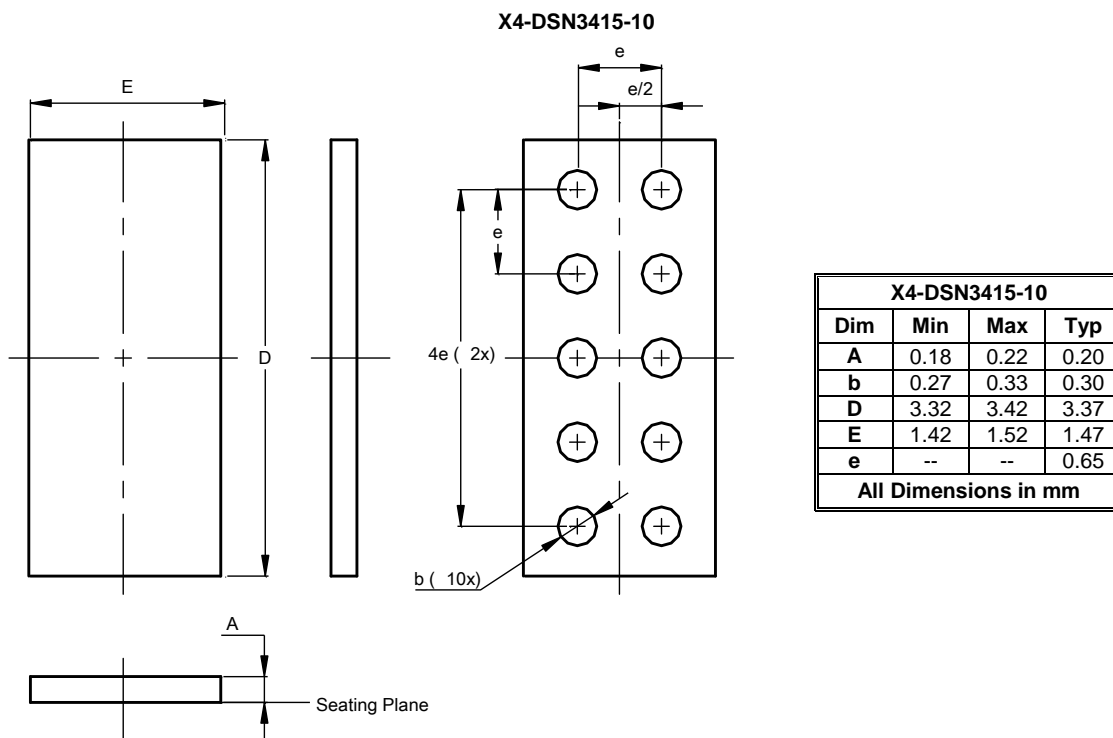


Figure 13. Transient Thermal Resistance

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

